

Patent
Attorney's Docket No. 000023-010

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Hideo ARIKAWA et al.

Application No.: 10/088,996

Filed: March 26, 2002.

**For: AQUEOUS DISPERSION
COMPOSITION FOR IMPARTING
CHIPPING RESISTANCE**

MAIL STOP AFTER FINAL

Group Art Unit: 1713

Examiner: Rip A. Lee

Confirmation No.: 8985

OK to enter
4/6/04
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MAR 11 2004

REPLY AND AMENDMENTS PURSUANT TO 37 C.F.R. §1.116

**Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

Sir:

In response to the Office Action [Final Rejection] mailed December 12, 2003,
please amend the above-identified patent application as follows: